

Evaluation Board

For XMC4000 Family

XMC4500 Relax Kit & XMC4500 Relax Lite Kit

Kit Version 1

Board User's Manual

Revision 1.1, 2012-11-09

Microcontroller

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Revision Histor	у					
Page or Item	Item Subjects (major changes since previous revision)					
Revision 1.0, 2012-11-07	Initial release					
Revison 1.1, 2012-11-09	Correction of DAVE™3 trademark					

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Table of Contents

Table of Contents

Introdu	ntroduction7					
1	Overview	7				
1.1	Key Features	7				
1.2	Block Diagram	8				
2	Hardware Description	g				
2.1	Power Supply	11				
2.2	Pin Header Connector	12				
3	Production Data	14				
3.1	Schematics	14				
3.2	Components Placement and Geometry					
3.3	List of Material					





List of Figures

List of Figures

Figure 1	Block Diagram of the XMC4500 Relax/Relax Lite Kit-V1	8
igure 2	XMC4500 Relax Lite Kit-V1	
Figure 3	XMC4500 Relax Kit-V1	
Figure 4	Power Supply Concept	
Figure 5	Signal mapping of the pin headers	
Figure 6	Mapping of communication peripherals to GPIOs and it's corresponding functions	13
igure 7	CPU, Pin Headers, Buttons, LEDs, Reset	15
Figure 8	On-board Debugger, Power Supply, Ethernet, Quad-SPI Memory, SD Card Slot, RTC Crystal	
igure 9	Components Placement and Geometry	17





List of Tables

List of Tables

Table 1	Features	7
Table 2	List of Material1	8



Overview

Introduction

This document describes the features and hardware details of the XMC4500 Relax Kit-V1 and the XMC4500 Relax Lite Kit-V1, both equipped with the ARM® Cortex™-M4 based XMC4500 Microcontroller from Infineon Technologies AG.

1 Overview

The XMC4500 Relax Kit-V1 and the XMC4500 Relax Lite Kit-V1 are designed to evaluate the capabilities of the XMC4500 Microcontroller and the powerful, free of charge tool chain DAVE™3. The XMC4500 Relax Kit extends the feature set with an Ethernet-enabled communication option, e.g. to run an embedded web server. You can store your own HTML web pages on a microSD Card or control the XMC4500 via the web browser on your PC.

The XMC4500 Relax Lite Kit-V1 does not support the web server application, because the components for the Ethernet are not assembled. Both boards are marked with "XMC4500 Relax/Relax Lite Kit-V1". These boards are neither cost nor size optimized and do not serve as a reference design.

1.1 Key Features

Table 1 summarizes the features of both the XMC4500 Relax Kit-V1 and the XMC4500 Relax Lite Kit-V1.

Table 1 Features

Feature	XMC4500 Relax Kit-V1	XMC4500 Relax Lite Kit-V1
XMC4500 Microcontroller	V	√
(ARM® Cortex™-M4F based)		
Detachable on-board Debugger	✓	√
Power over USB	V	√
2 x User Button and 2 x User LED	✓	√
Reset Button	✓	√
Power Regulator from 5 V to 3.3V	✓	√
4 x SPI-Master, 3x I2C, 3 x I2S, 3 x UART, 2 x CAN, 17 x ADC (12 bit), 2 x DAC, 31x PMW mapped on 2 Pin Headers 2 x 20	✓	✓
USB-OTG (Micro USB Plug)	✓	√
Ethernet PHY and RJ45 jack	√	
Real Time Clock Crystal	√	
32 Mbit Quad-SPI Flash Memory	√	
microSD Card Slot	√	



Overview

1.2 Block Diagram

The block diagram in Figure 1 shows the main components of the XMC4500 Relax/Relax Lite Kit-V1 and their interconnections. There are following main building blocks:

- XMC4500 Microcontroller in a LQFP100 package
- On-board USB debugger realized with a 2nd XMC4500 for serial wire debug
- Ethernet Phy with RJ45 Plug
- Two 40 pin header X1 and X2
- On-board power generation for power supply of the XMC45000 Microcontroller and the debug IC
- 2 User Buttons and 2 User LEDs
- USB Plug
- microSD Card Slot

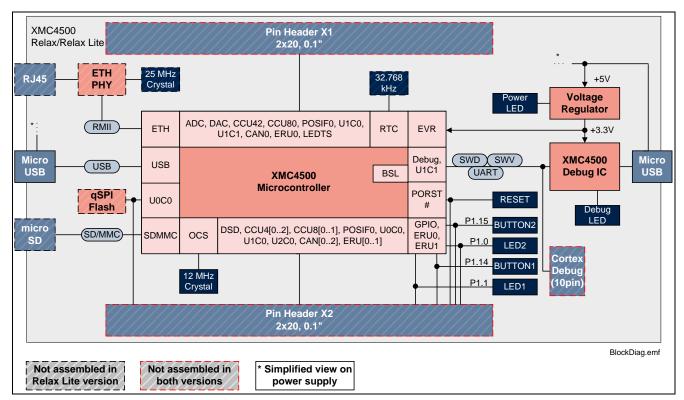


Figure 1 Block Diagram of the XMC4500 Relax/Relax Lite Kit-V1



2 Hardware Description

The following sections give a detailed description of the board hardware and how it can be used. Figure 2 shows the XMC4500 Relax Lite Kit-V1, Figure 3 shows the XMC4500 Relax Kit-V1.

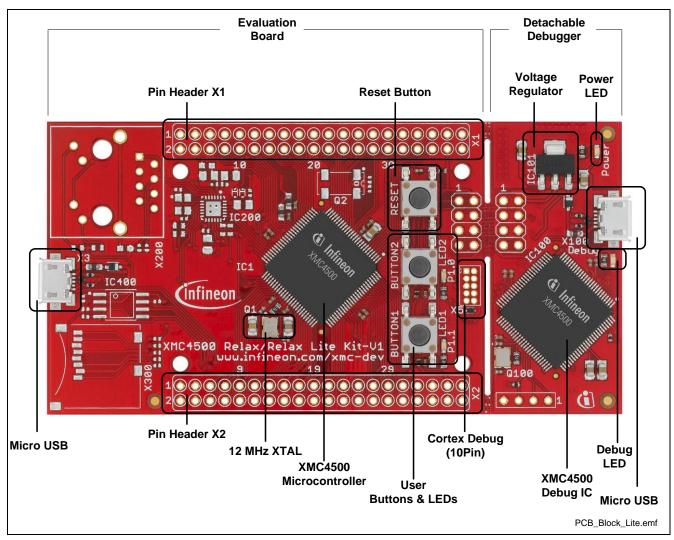


Figure 2 XMC4500 Relax Lite Kit-V1



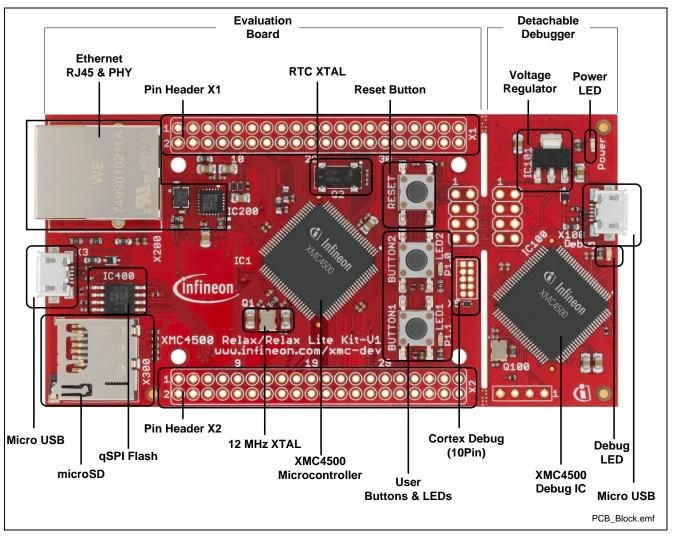


Figure 3 XMC4500 Relax Kit-V1



2.1 Power Supply

The XMC4500 Relax/Relax Lite Kit-V1 must be supplied by an external 5 Volt DC power supply connected to any of the Micro UBS plugs (X3, X100). Out of the box with the pre-programmed web server application and the on-board debugger in operation the XMC4500 Relax Kit-V1 typically draws about 250 mA. The XMC4500 Relax Lite Kit-V1 without the web server capabilities draws about 200 mA. This current can be delivered via the USB plug of a PC, which is specified to deliver up to 500 mA. The Power LED indicates the presence of the generated 3.3V supply voltage.

On-board reverse current protection diodes will ensure safe operation in case power is provided through both USB plugs at the same time. These protection diodes allows to use the on-board debugger connected with a PC/Notebook via X100 and a second host PC/Laptop connected with the XMC4500 Relax Kit via X3.

If the board is powered via a USB plug, it's not recommended to apply an additional 5 Volt power supply to one of the 5 Volt power pins (VDD5) on the pin headers X1 or X2, because there is no protection against reverse current into the external power supply. These power pins can be used to power an external circuit. But care must be taken not to draw more current than USB can deliver. A PCs as USB host typically can deliver up to 500 mA current. If higher currents are required and in order to avoid damages on the USB host the use of an external USB power supply unit which is able to deliver higher currents than 500 mA is strongly recommended.

After power-up the Debug LED starts blinking. In case there is a connection to a PC via the Debug USB plug X100 and the USB Debug Device drivers are installed on this PC, the Debug LED will turn from blinking to constant illumination.

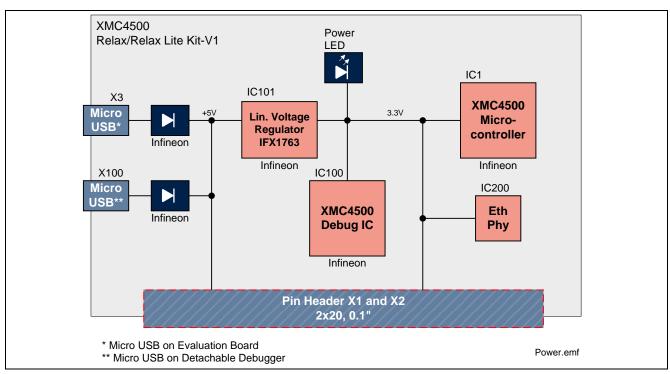


Figure 4 Power Supply Concept



2.2 Pin Header Connector

The pin headers X1 and X2 can be used to extend the evaluation board or to perform measurements on the XMC4500. Figure 5 shows the available GPIOs/signals at the pin headers. The pinning table is also printed onto the bottom side of the PCB.

	Pin Header X2			(Top View)	Pin Hea	ader X1
	2	1	_		2	1
	GND	GND			GND	GND
4	GND	GND	3	4	GND	GND
6	P5.7	P2.6	5	6	RESET#	GND
8	P5.1	P5.2	7	8	P2.10	P2.1
10	P1.15	P5.0	9	10	P14.8	P2.14
12	P1.13	P1.14	11	12	P14.9	P2.15
14	P1.11	P1.12	13	14	P14.0	VAREF
16	P1.5	P1.10	15	16	P14.2	P14.1
18	P1.3	P1.4	17	18	P14.4	P14.3
20	P1.1	P1.2	19	20	P14.6	P14.5
22	P1.9	P1.0	21	22	P14.12	P14.7
24	P0.8	P1.8	23	24	P14.14	P14.13
26	P3.4	P0.7	25	26	P15.2	P14.15
28	P0.12	P3.3	27	28	HIB_IO_0	P15.3
30	P0.6	P0.11	29	30	P3.0	HIB_IO_1
32	P0.2	P0.5	31	32	P3.2	P3.1
34	P0.4	P0.3	33	34	P0.1	P0.9
36	GND	GND	35	36	P0.0	P0.10
38	VDD3.3	VDD3.3	37	38	VDD3.3	VDD3.3
40	VDD5	VDD5	39	40	VDD5	VDD5

Figure 5 Signal mapping of the pin headers

The XMC4500 provides a flexible mapping of functions to different pins. Figure 6 shows an example how the communication peripheral functions UART, I2C, SPI, CAN and I2S can be mapped to XMC4500's GPIOs.

GPIOs with the same colour code belong to the same group of physical pins and cannot be choosen twice. For instance UART-3 has got a pin overlap with I2C-Master1 and therefore this combination cannot work in parallel.

Please also avoid pheripheral combinations which are using the same USIC channel. For example I2C-Master2 and UART-3 utilizing USIC 0 Channel 0 (U0C0), therefore this combination does not work in parallel.



UART	UART-1	UART-2	UART-3	UART-4		
TX	P0.1 / U1C1.DOUT0	P1.5 / U0C0.DOUT0	P5.1 / U0C0.DOUT0	P0.5 / U1C0.DOUT0		
RX	P0.0 / U1C1.DX0D	P1.4 / U0C0.DX0B	P5.0 / U0C0.DX0D	P0.4 / U1C0.DX0A		
2C Master/Slave	I2C-Master1	I2C-Master2	I2C-Master3	I2C-Slave1	I2C-Slave2	
SCL (clock)	P5.2 / U2C0.SCLKOUT	P1.10 / U0C0.SCLKOUT	P0.11 / U1C0.SCLKOUT	P5.2 / U2C0.DX1A	P0.11 / U1C0.DX1A	
SDA (data)	P5.0 / U2C0.DOUT0 / .DX0B	P1.5 / U0C0.DOUT0 /.DX0A	P0.5 / U1C0.DOUT0 /.DX0B	P5.0 /U2C0.DOUT0 / .DX0B	P0.5 / U1C0.DOUT0 /.DX0B	
PI Master/Slave	SPI-Master1	SPI-Master2	SPI-Master3	SPI-Master4	SPI-Slave1	SPI-Slave2
MOSI	P0.1 / U1C1.DOUT0	P5.0 / U2C0.DOUT0	P1.5 / U0C0.DOUT0	P0.5 / U1C0.DOUT0	P0.0 / U1C1.DX0D	P0.4 / U1C0.DX0A
MISO	P0.0 / U1C1.DX0D	P5.1 / U2C0.DX0A	P1.4 / U0C0.DX0B	P0.4 / U1C0.DX0A	P0.1 / U1C1.DOUT0	P0.5 / U1C0.DOUT0
SCK (clock)	P0.10 / U1C1.SCLKOUT	P5.2 / U2C0.SCLKOUT	P1.10 / U0C0.SCLKOUT	P0.11 / U1C0.SCLKOUT	P0.10 / U1C1.DX1A	P0.11 / U1C0.DX1A
CS (chip select)	P0.9 / U1C1.SELO0*	P2.6 / U2C0.SELO4	P1.11 / U0C0.SELO0**	P0.6 / U1C0.SELO0	P0.9 / U1C1.DX2A	P0.6 / U1C0.DX2A
			_			
CAN	CAN-1	CAN-2				
TX	P1.12 / CAN.N1_TXD	P1.4 / CAN.N0_TXD				
RX	P1.13 / CAN.N1_RXDC	P1.5 / CAN.NO_RXDA				
				1	7	
2S Master/Slave	I2C-Master1	I2C-Master2	I2C-Master3	I2C-Slave1		
SCK (clock)	P5.2 / U2C0.SCLKOUT	P1.10 / U0C0.SCLKOUT	P0.11 / U1C0.SCLKOUT	P0.11 / U1C0.DX1A		
SD (data)	P5.0 / U2C0.DOUT0 / .DX0B	P1.5 / U0C0.DOUT0 /.DX0A	P0.5 / U1C0.DOUT0 /.DX0B	P5.0 / U2C0.DOUT0 / .DX0B	=	
WS (wait)	P2.6 / U2C0.SEL04	P1.11 / U0C0.SELO0	P0.6 / U1C0.SELO0	P0.6 / U2C0.DX2A		

Figure 6 Mapping of communication peripherals to GPIOs and it's corresponding functions



3 Production Data

3.1 Schematics

This chapter contains the schematics for the XMC4500 Relax/Relax Lite Kit-V1:

- Figure 7: CPU, Pin Headers, Buttons, LEDs, Reset
- Figure 8: On-board Debugger, Power Supply, Ethernet, Quad-SPI Memory, SD Card Slot, RTC Crystal



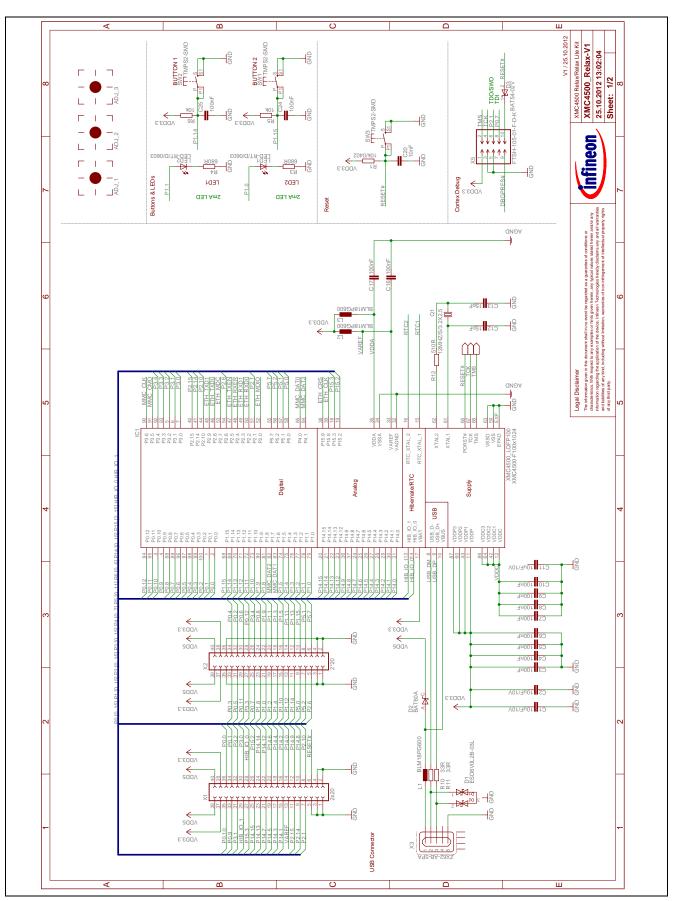


Figure 7 CPU, Pin Headers, Buttons, LEDs, Reset



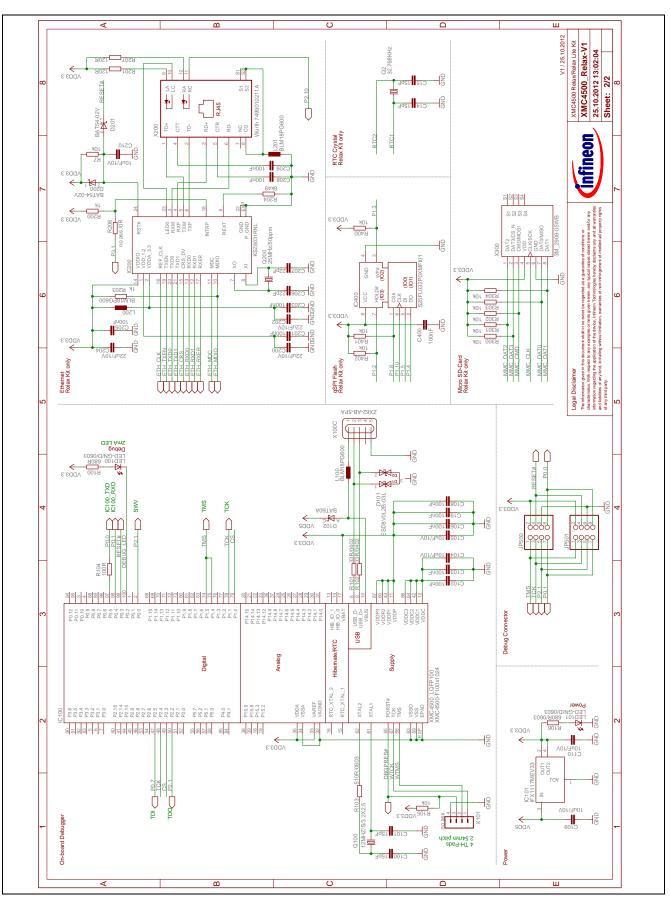


Figure 8 On-board Debugger, Power Supply, Ethernet, Quad-SPI Memory, SD Card Slot, RTC Crystal

Board Users Manual 16 Revision 1.1, 2012-11-09



3.2 Components Placement and Geometry

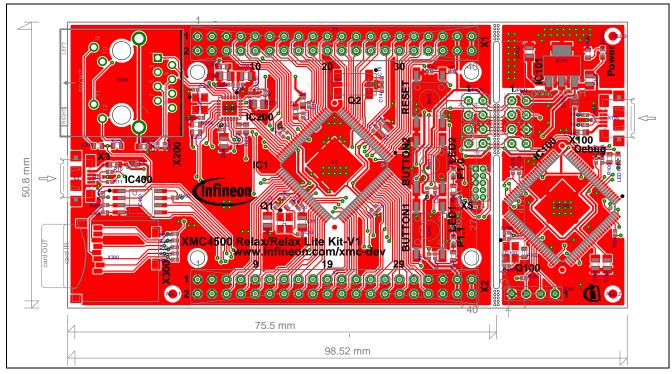


Figure 9 Components Placement and Geometry



3.3 List of Material

The list of material is valid for the XMC4500 Relax/Relax Lite Kit-V1.

Table 2 List of Material

No.	Qty	Value	Device	Reference Designator		
1	2	2x4	Pin Header 0.1" TH	JP500, JP501		
2	2	1k	Resistor	R200, R203		
3	1	2*20	Pin Header 0.1" TH	X2		
4	1	2x20	Pin Header 0.1" TH	X1		
5	1	3M_2908-05WB	microSD Card Holder	X300		
6	1	6k49	Resistor	R204		
7	12	10k	Resistor	R5, R6, R7, R105, R300, R301, R302, R303, R304, R400, R401, R402		
8	1	10k/0402	Resistor	R1		
9	1	10nF	Capacitor	C20		
10	8	10uF/10V	Capacitor	C1, C2, C11, C104, C105, C109, C110, C210		
11	2	12MHz/S/3.2X2.5	Crystal 12 MHz	Q1, Q100		
12	6	15pF	Capacitor	C12, C13, C14, C15, C100, C101		
13	2	22pF	Capacitor	C206, C207		
14		22uF/10V	Capacitor	C200, C202, C204		
15	1	25MHz/50ppm	Crystal 12 MHz	Q200		
16	1	32.768KHz	Crystal 32 kHz	Q2		
17	2	33R	Resistor	R10, R11		
18	2	33R/0402	Resistor	R101, R102		
19		100R	Resistor	R104		
20	23	100nF	Capacitor	C3, C4, C5, C6, C7, C8, C9, C10, C16, C17, C19, C24, C25, C102, C103, C106, C108, C201, C203, C205, C208, C209, C400		
21	2	120R	Resistor	R201, R207		
22	1	510R	Resistor	R12		
23	1	510R/0603	Resistor	R103		
24		680R	Resistor	R3, R4, R100		
25	1	680R/0603	Resistor	R106		
26	3	BAT54-02V	Schottky Diode, Infineon	D3, D200, D201		
27	2	BAT60A	Schottky Diode, Infineon	D2, D102		
28	6	BLM18PG600	Inductor	L1, L2, L3, L100, L200, L201		
29	2	ESD8V0L2B-03L	TVS Diode, Infineon	D1, D101		
30	3	FIDUCIAL	FIDUCIAL	ADJ_1, ADJ_2, ADJ_3		
31	1	FTSH-105-01-F-D-K	Connector 2x5, Samtec	X5		
32	1	IFX1117MEV33	Linear Voltage Regulator, Infineon	IC101		
33	+	KSZ8031RNL	Ethernet Phy, Micrel	IC200		
34		LED-GN/D/0603	LED green	LED100, LED101		
35		LED-RT/D/0603	LED red	LED1, LED2		
36		S25FL032P0XMFI01	Quad-SPI Flash, Spansion	IC400		



Table 2 List of Material

No.	Qty	Value	Device	Reference Designator
37	3	TMPS2-SMD	Push Button	SW1, SW2, SW3
38	1	7499010211A	Ethernet RJ45 Plug, Würth	X200
			Microcontroller Cortex	
39	2	XMC4500-F100F1024	M4F, Infineon	IC1, IC100
40	2	ZX62-AB-5PA	Micro USB Plug	X3, X100
41	1	no ass.	Pin Header 1x4	X101
42	1	no ass./0R	Resistor	R206

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